



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





TS272C,I,M

HIGH PERFORMANCE CMOS DUAL OPERATIONAL AMPLIFIERS

- OUTPUT VOLTAGE CAN SWING TO GROUND
- EXCELLENT PHASE MARGIN ON CAPACITIVE LOADS
- GAIN BANDWIDTH PRODUCT: **3.5MHz**
- STABLE AND LOW OFFSET VOLTAGE
- THREE INPUT OFFSET VOLTAGE SELECTIONS

DESCRIPTION

The TS272 devices are low cost, dual operational amplifiers designed to operate with single or dual supplies. These operational amplifiers use the ST silicon gate CMOS process allowing an excellent consumption-speed ratio. These series are ideally suited for low consumption applications.

Three power consumptions are available allowing to have always the best consumption-speed ratio:

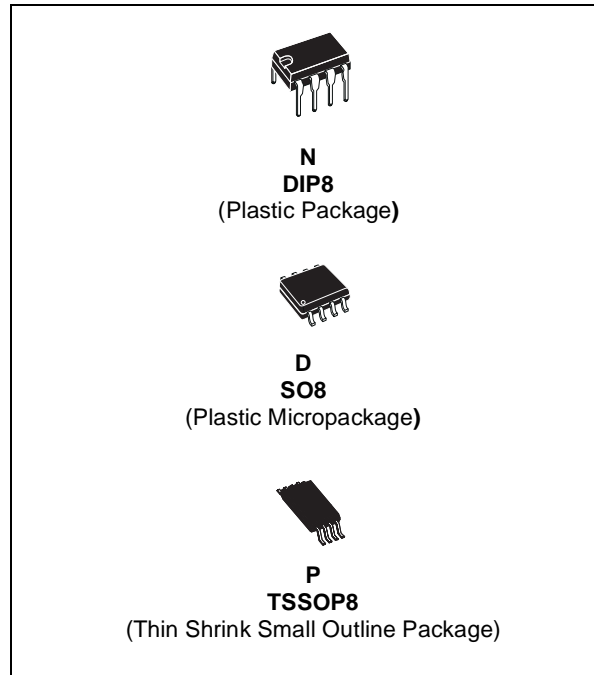
- $I_{CC} = 10\mu\text{A}/\text{amp.}$: TS27L2 (very low power)
- $I_{CC} = 150\mu\text{A}/\text{amp.}$: TS27M2 (low power)
- $I_{CC} = 1\text{mA}/\text{amp.}$: TS272 (standard)

These CMOS amplifiers offer very high input impedance and extremely low input currents. The major advantage versus JFET devices is the very low input currents drift with temperature (see figure 2).

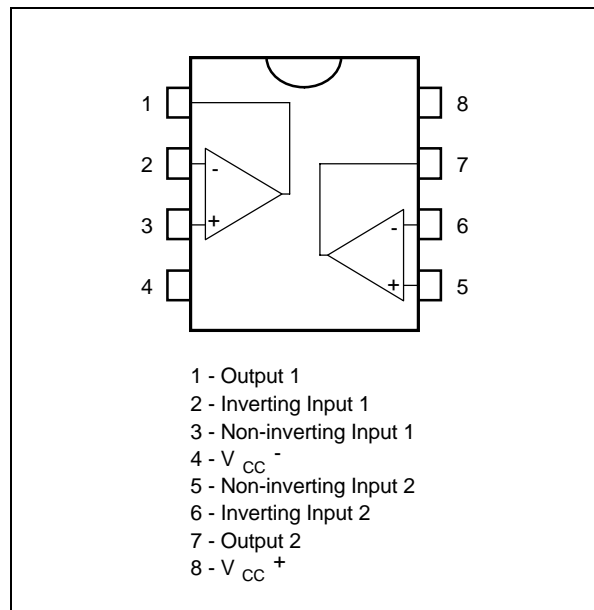
ORDER CODE

Part Number	Temperature Range	Package		
		N	D	P
TS272C/AC/BC	0°C, +70°C	•	•	•
TS272I/AI/BI	-40°C, +125°C	•	•	•
TS272M/AM/BM	-55°C, +125°C	•	•	•
Example : TS272ACN				

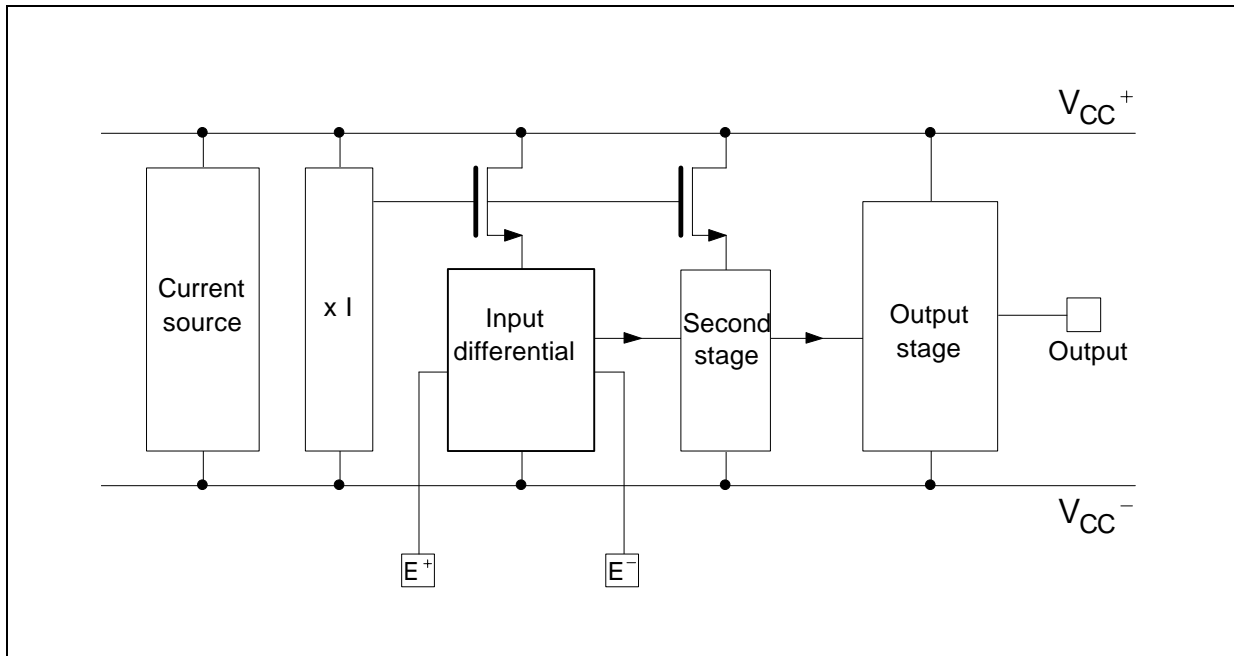
N = Dual in Line Package (DIP)
D = Small Outline Package (SO) - also available in Tape & Reel (DT)
P = Thin Shrink Small Outline Package (TSSOP) - only available in Tape & Reel (PT)



PIN CONNECTIONS (top view)



BLOCK DIAGRAM



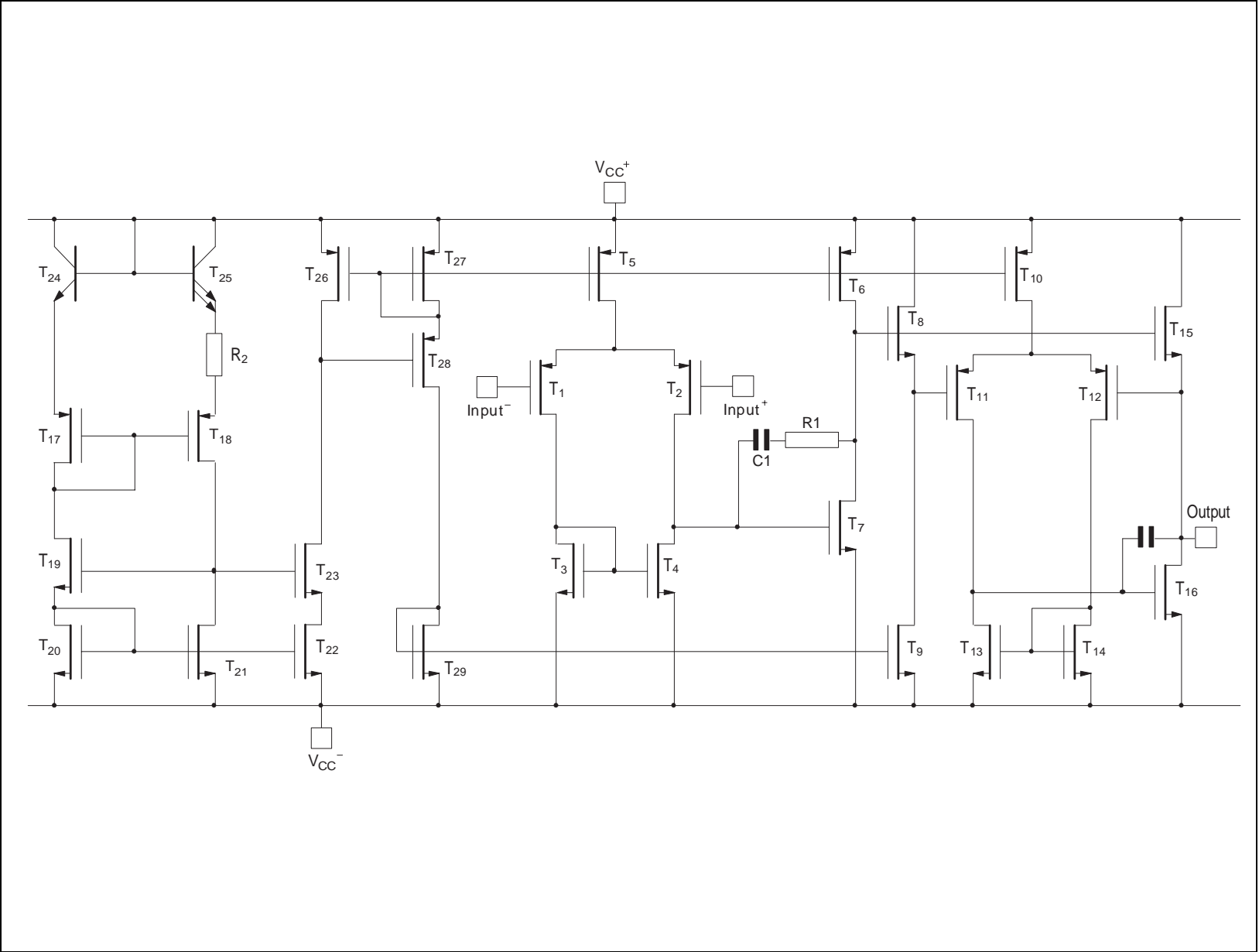
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	TS272C/AC/BC	TS272I/AI/BI	TS272M/AM/BM	Unit
V_{CC}^+	Supply Voltage ¹⁾	18			V
V_{id}	Differential Input Voltage ²⁾	±18			V
V_i	Input Voltage ³⁾	-0.3 to 18			V
I_o	Output Current for $V_{CC}^+ \geq 15V$	±30			mA
I_{in}	Input Current	±5			mA
T_{oper}	Operating Free-Air Temperature Range	0 to +70	-40 to +125	-55 to +125	°C
T_{stg}	Storage Temperature Range	-65 to +150			°C

1. All values, except differential voltage are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of the input and the output voltages must never exceed the magnitude of the positive supply voltage.

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply Voltage	3 to 16	V
V_{icm}	Common Mode Input Voltage Range	0 to $V_{CC}^+ - 1.5$	V



SCHEMATIC DIAGRAM (for 1/2 TS272)

TS272C,I,M

ELECTRICAL CHARACTERISTICS

$V_{CC}^+ = +10V$, $V_{CC}^- = 0V$, $T_{amb} = +25^\circ C$ (unless otherwise specified)

Symbol	Parameter	TS272C/AC/BC			TS272I/AI/BI TS272M/AM/BM			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input Offset Voltage $V_O = 1.4V$, $V_{ic} = 0V$ TS272C/I/M TS272AC/AI/AM TS272B/C/I/M $T_{min} \leq T_{amb} \leq T_{max}$ TS272C/I/M TS272AC/AI/AM TS272B/C/I/M		1.1 0.9 0.25	10 5 2 12 6.5 3		1.1 0.9 0.25	10 5 2 12 6.5 3	mV
DV_{io}	Input Offset Voltage Drift		2			2		$\mu V/^\circ C$
I_{io}	Input Offset Current note 1) $V_{ic} = 5V$, $V_O = 5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	100		1	200	pA
I_{ib}	Input Bias Current - see note 1 $V_{ic} = 5V$, $V_O = 5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	150		1	300	pA
V_{OH}	High Level Output Voltage $V_{id} = 100mV$, $R_L = 10k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$	8.2 8.1	8.4		8.2 8	8.4		V
V_{OL}	Low Level Output Voltage $V_{id} = -100mV$			50			50	mV
A_{vd}	Large Signal Voltage Gain $V_{ic} = 5V$, $R_L = 10k\Omega$, $V_O = 1V$ to $6V$ $T_{min} \leq T_{amb} \leq T_{max}$	10 7	15		10 6	15		V/mV
GBP	Gain Bandwidth Product $A_v = 40dB$, $R_L = 10k\Omega$, $C_L = 100pF$, $f_{in} = 100kHz$		3.5			3.5		MHz
CMR	Common Mode Rejection Ratio $V_{ic} = 1V$ to $7.4V$, $V_O = 1.4V$	65	80		65	80		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = 5V$ to $10V$, $V_O = 1.4V$	60	70		60	70		dB
I_{CC}	Supply Current (per amplifier) $A_v = 1$, no load, $V_O = 5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1000	1500 1600		1000	1500 1700	μA
I_o	Output Short Circuit Current $V_O = 0V$, $V_{id} = 100mV$		60			60		mA
I_{sink}	Output Sink Current $V_O = V_{CC}$, $V_{id} = -100mV$		45			45		mA
SR	Slew Rate at Unity Gain $R_L = 10k\Omega$, $C_L = 100pF$, $V_i = 3$ to $7V$		5.5			5.5		V/ μs
ϕ_m	Phase Margin at Unity Gain $A_v = 40dB$, $R_L = 10k\Omega$, $C_L = 100pF$		40			40		Degrees
K_{OV}	Overshoot Factor		30			30		%
e_n	Equivalent Input Noise Voltage $f = 1kHz$, $R_s = 100\Omega$		30			30		$\frac{nV}{\sqrt{Hz}}$
V_{o1}/V_{o2}	Channel Separation		120			120		dB

1. Maximum values including unavoidable inaccuracies of the industrial test.

TYPICAL CHARACTERISTICS

Figure 1 : Supply Current (each amplifier) versus Supply Voltage

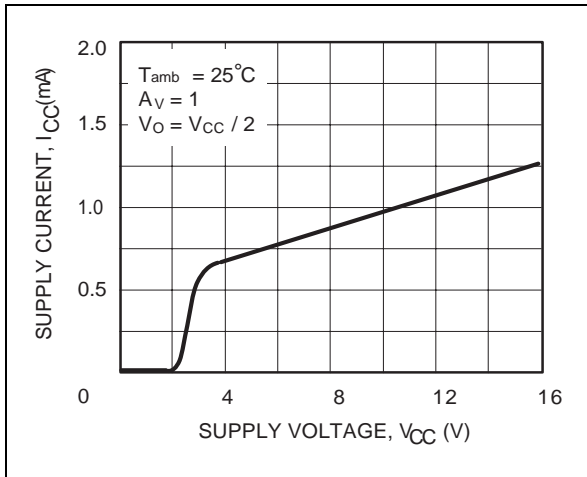


Figure 2 : Input Bias Current versus Free Air Temperature

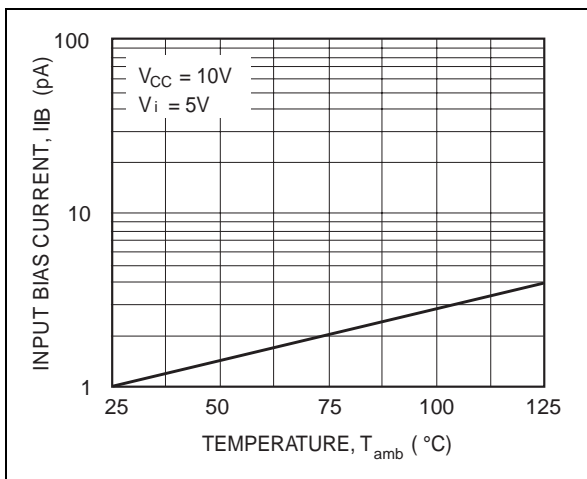


Figure 3a : High Level Output Voltage versus High Level Output Current

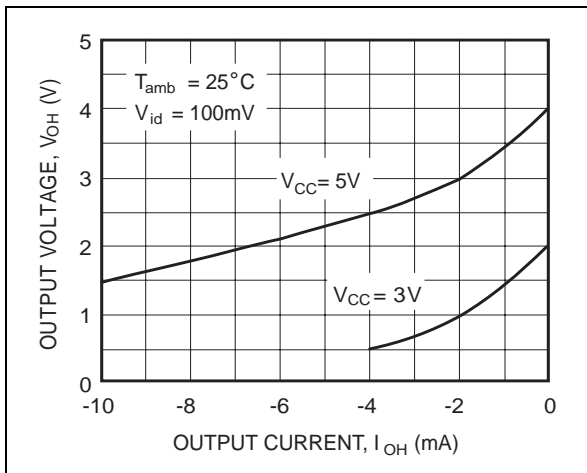


Figure 3b : High Level Output Voltage versus High Level Output Current

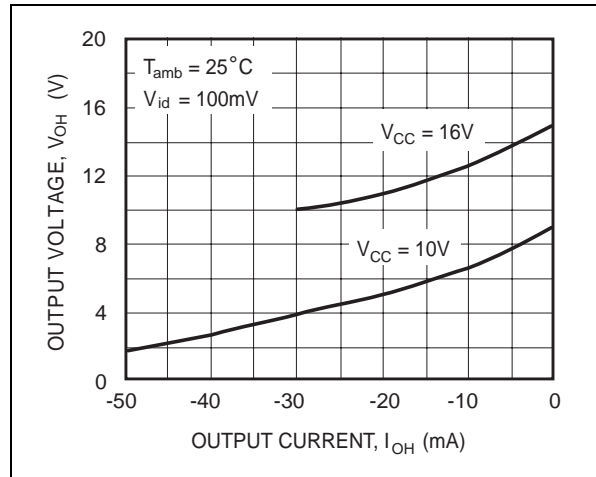


Figure 4a : Low Level Output Voltage versus Low Level Output Current

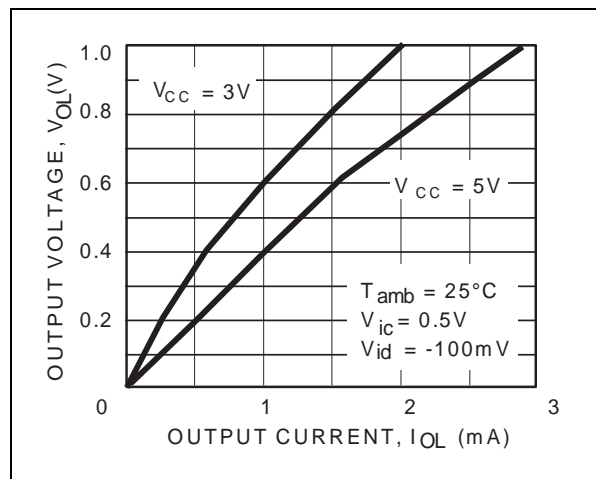


Figure 4b : Low Level Output Voltage versus Low Level Output Current

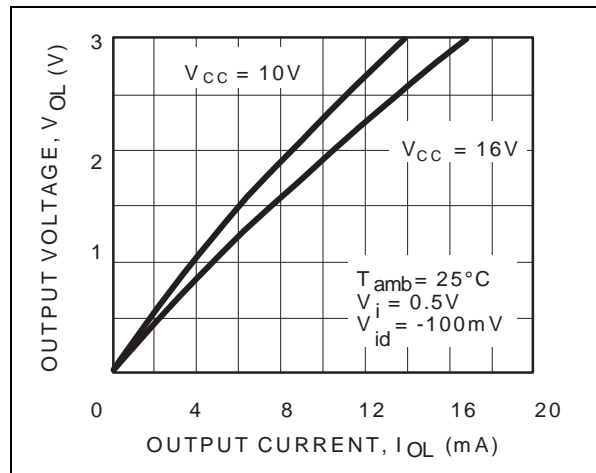


Figure 5 : Open Loop Frequency Response and Phase Shift

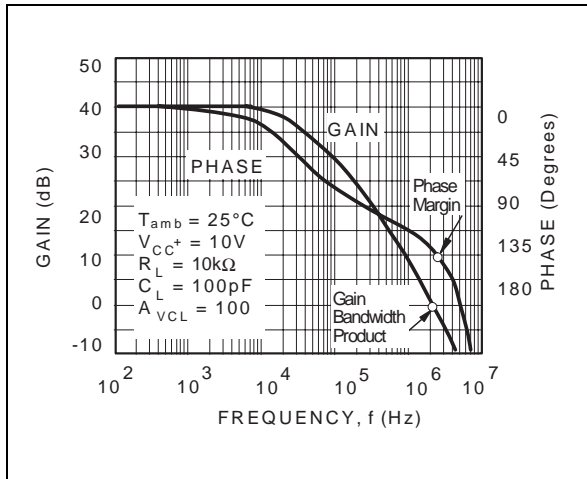


Figure 6 : Gain Bandwidth Product versus Supply Voltage

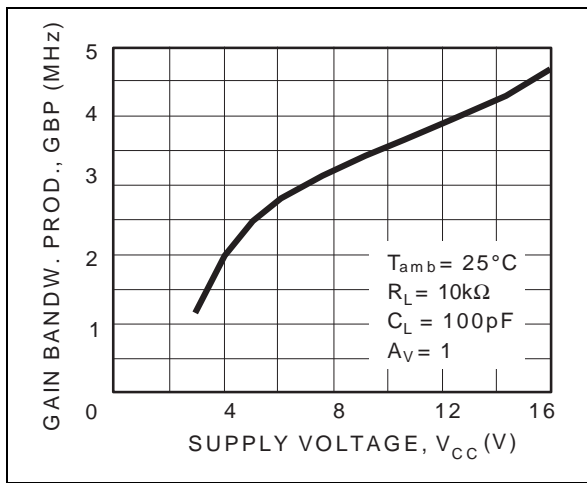


Figure 7 : Phase Margin versus Supply Voltage

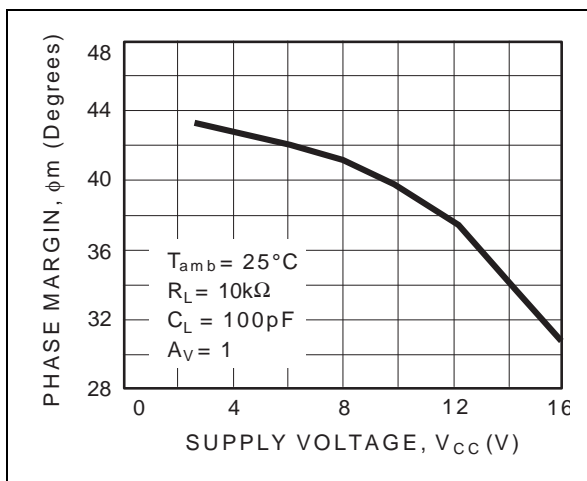


Figure 8 : Phase Margin versus Capacitive Load

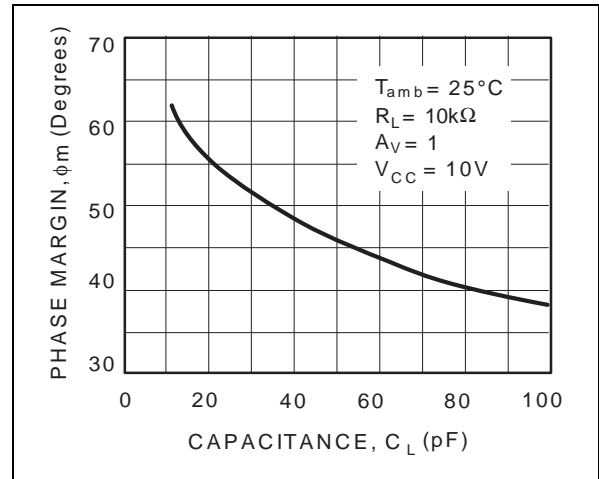


Figure 9 : Slew Rate versus Supply Voltage

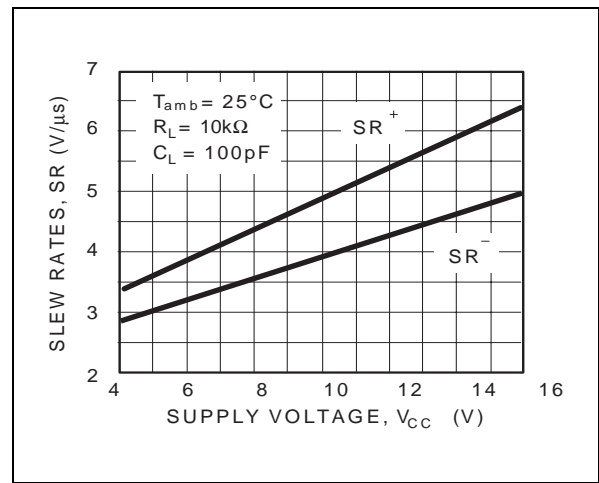
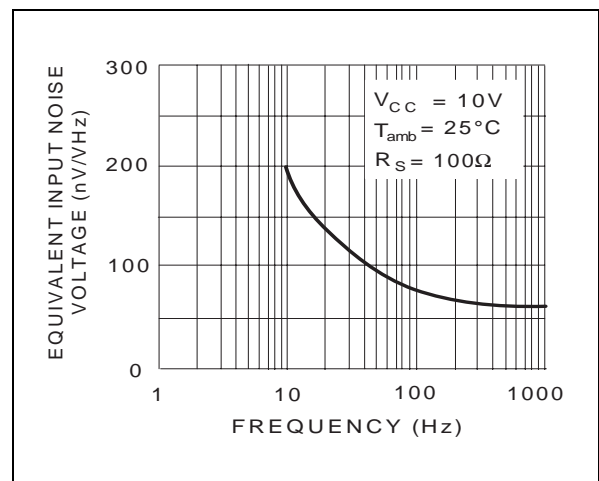
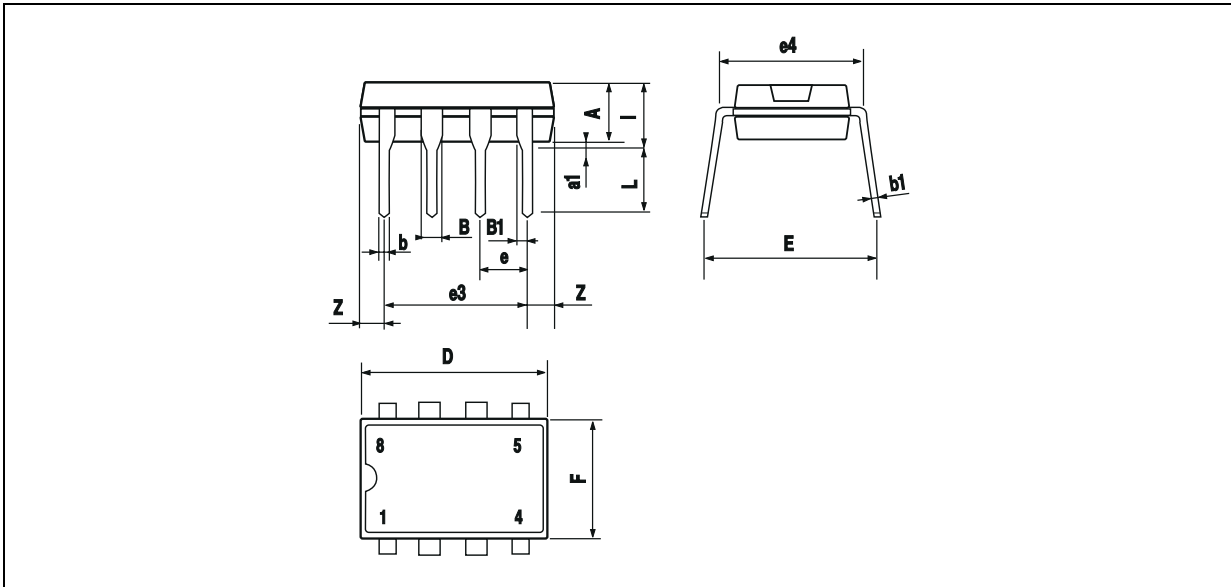


Figure 10 : Input Voltage Noise versus Frequency

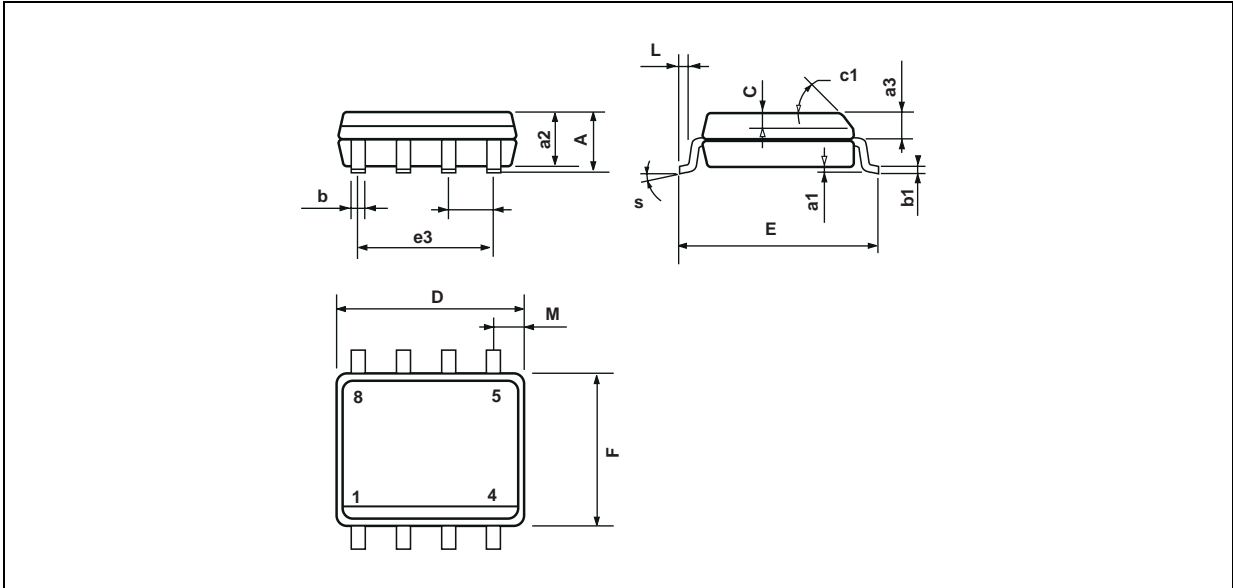


PACKAGE MECHANICAL DATA
8 PINS - PLASTIC DIP



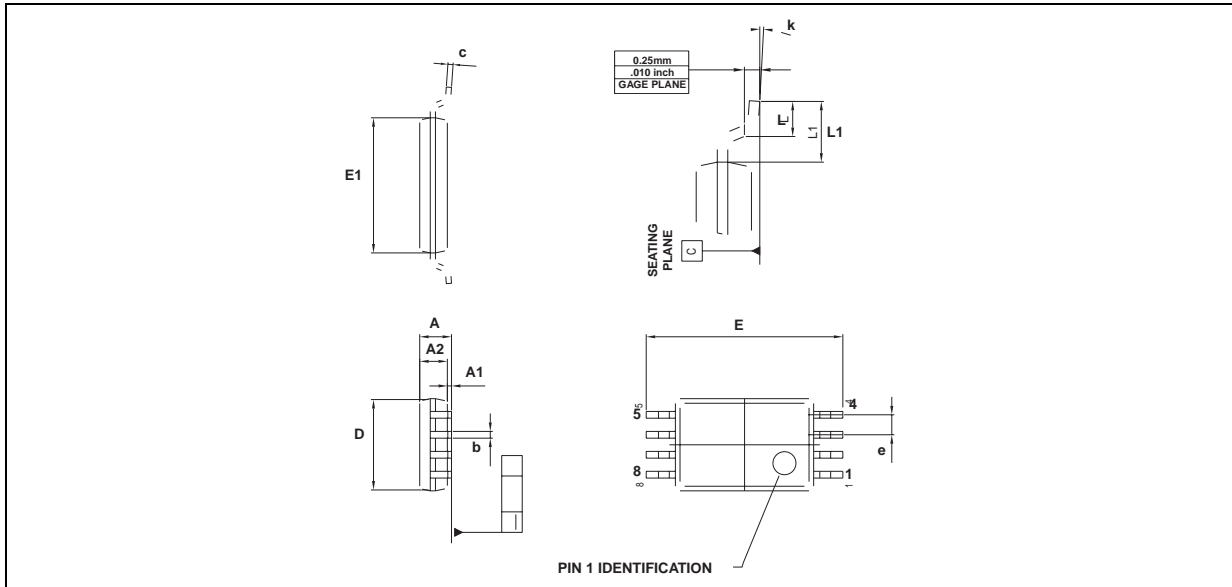
Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

PACKAGE MECHANICAL DATA
8 PINS - THIN SHRINK SMALL OUTLINE PACKAGE (TSSOP)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.20			0.05
A1	0.05		0.15	0.01		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.15
c	0.09		0.20	0.003		0.012
D	2.90	3.00	3.10	0.114	0.118	0.122
E		6.40			0.252	
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.025	
k	0°		8°	0°		8°
l	0.50	0.60	0.75	0.09	0.0236	0.030
L	0.45	0.600	0.75	0.018	0.024	0.030
L1		1.000			0.039	

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

© The ST logo is a registered trademark of STMicroelectronics

© 2001 STMicroelectronics - Printed in Italy - All Rights Reserved
 STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia
 Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States

© <http://www.st.com>

